

DDR Termination Regulator

General Description

The RT2568A is a sink/source tracking termination regulator. It is specifically designed for low-cost and low-external component count systems. The RT2568A possesses a high speed operating amplifier that provides fast load transient response and only requires a minimum $10\mu F\ x\ 3$ ceramic output capacitors. The RT2568A supports remote sensing functions and all features required to power the DDRIII and Low Power DDRIII / DDRIV VTT bus termination according to the JEDEC specification. In addition, the RT2568A provides an open-drain PGOOD signal to monitor the output regulation and an EN signal that can be used to discharge VTT during S3 (suspend to RAM) for DDR applications.

The RT2568A is available in the thermal efficient package, WDFN-10L 3x3.

Features

VIN Input Voltage Range: 1.1V to 3.5V
VCNTL Input Voltage Range: 2.9V to 5.5V

• Support Ceramic Capacitors

• Power Good Indicator

• 10mA Source/Sink Reference Output

• Meet DDRI, DDRII JEDEC Spec

 Support DDRI, DDRII, DDRIII and Low Power DDRIII/ DDRIV VTT Applications

Soft-Start Function

UVLO and OCP Protection

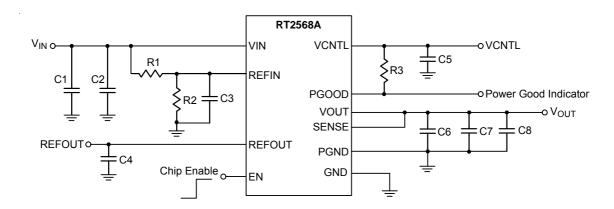
• Thermal Shutdown

Applications

- Notebook/Desktop/Server
- Telecom/Datacom, GSM Base Station, LCD-TV/PDP-TV, Copier/Printer, Set-Top Box

Simplified Application Circuit

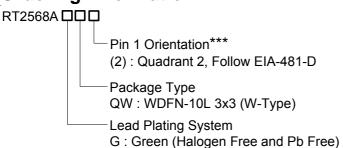
DS2568A-00 May 2020



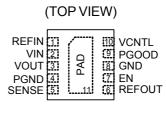
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Ordering Information



Pin Configuration



WDFN-10L 3x3

Note:

***Empty means Pin1 orientation is Quadrant 1 Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information



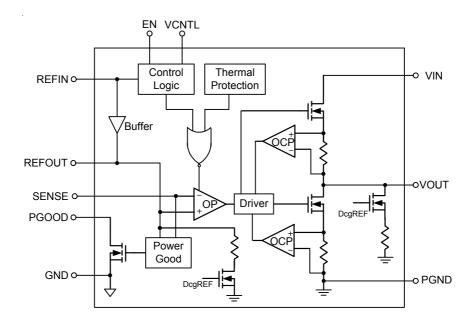
8K=: Product Code YMDNN: Date Code

Functional Pin Description

Pin No.	Pin Name	Pin Function
1	REFIN	Reference input.
2	VIN	Power input of the regulator.
3	VOUT	Power output of the regulator.
4	PGND	Power ground of the regulator.
5	SENSE	Voltage sense input for the regulator. Connect to positive terminal of the output capacitor or the load.
6	REFOUT	Reference output. Connect to GND through a 0.1µF ceramic capacitor.
7	EN	Enable control input. Control the device ON/OFF function.
9	PGOOD	Power good open-drain output. Connect a pull-up resistor between this pin and VCNTL pin.
10	VCNTL	Control voltage input. Connect this pin to the 3.3V or 5V power supply. A ceramic decoupling capacitor with value range from $1\mu F$ to $4.7\mu F$ is suggested.
8	GND	Analog ground. Connect to negative terminal of the output capacitor.
11 (Exposed Pad)	PAD	Exposed pad. The exposed pad is internally unconnected and must be soldered to a large PGND plane. Connect this PGND plane to other layers with thermal vias to help dissipate heat from the device.



Functional Block Diagram



Operation

The RT2568A is a linear sink/source DDR termination regulator with current capability up to 3A. The RT2568A builds in a high-side N-MOSFET which provides current sourcing and a low-side N-MOSFET which provides current sinking. All the control circuits are supplied by the power VCNTL. In normal operation, the error amplifier OP adjusts the gate driving voltage of the power MOSFET to achieve SENSE voltage well tracking the REFIN voltage.

Buffer

This function provides REFOUT output which is equal to V_{REFIN} with 10mA source/sink current capability.

Power Good

When the SENSE voltage is in the power good window and lasts for a certain delay time, then the PGOOD pin will be high impedance and the PGOOD voltage will be pulled high by the external resistor.

Over-Current Protection

The device continuously monitors the output current to protect the pass transistor against abnormal operations. Both the source and sink currents are detected by the internal sensing resistor, and the OCP function will work to limit the current to a designed value when overload happens.

Control Logic

This block includes VCNTL UVLO, REFIN UVLO and Enable/Disable functions, and provides logic control to the whole chip.

Thermal Protection

Both the high-side and low-side power MOSFETs will be turned off when the junction temperature is higher than typically 160°C.

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Absolute Maximum Ratings (Note 1)

• Supply Voltage, VIN, VCNTL	-0.3V to 6V
• Input Voltage, EN, REFIN, SENSE	-0.3V to 6V
Output Voltage, VOUT, REFOUT, PGOOD	-0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
WDFN-10L 3x3	3.27W
Package Thermal Resistance (Note 2)	
WDFN-10L 3x3, θ_{JA}	30.5°C/W
WDFN-10L 3x3, θ_{JC}	7.5°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	150°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
Recommended Operating Conditions (Note 4)	

Electrical Characteristics

 $(V_{IN} = 1.5V, V_{EN} = V_{CNTL} = 3.3V, V_{REFIN} = V_{SENSE} = 0.75V, C_{OUT} = 10 \mu F x 3, T_A = -40 ^{\circ}C$ to 85 $^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit			
Supply Current									
VCNTL Supply Current	Supply Current IVCNTL VEN = VCNTL, no load				1	mA			
VCNTL Shutdown Current	ISHDN_VCNTL	V _{EN} = 0V, V _{REFIN} = 0V, no load	65 80						
VCNTE Shuldown Current		V _{EN} = 0V, V _{REFIN} > 0.4V, no load		200	400	μΑ			
VIN Supply Current	I _{VIN}	V _{EN} = V _{CNTL} , no load		1	50	μА			
VIN Shutdown Current	I _{SHDN_VIN}	V _{EN} = 0V, no load		0.1	50	μА			
Output			•			•			
VTT Output Voltage	Vоито	V _{IN} = 1.5V, V _{REFIN} = 0.75V, I _{OUT} = 0A		0.75					
		V _{IN} = 1.35V, V _{REFIN} = 0.675V, I _{OUT} = 0A		0.675		V			
		V _{IN} = 1.2V, V _{REFIN} = 0.6V, I _{OUT} = 0A		0.6					
	Vout_os	I _{OUT} < ±2A, V _{LDOIN} = 1.5V, V _{OUT_OS} = V _{OUT} - V _{OUTO}	-25		25				
VTT Output Voltage Offset		I _{OUT} < ±2A, V _{LDOIN} = 1.35V, V _{OUT_OS} = V _{OUT} - V _{OUTO}	-25		25	mV			
		I _{OUT} < ±2A, V _{LDOIN} = 1.2V, V _{OUT_OS} = V _{OUT} - V _{OUTO}	-25		25				

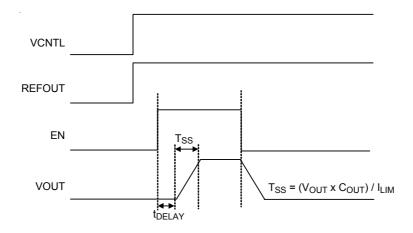
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Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit		
VOUT Source Curr	ent Limit	I _{LIM_} VOUT_SR	OUT SR VOUT in PGOOD window		4.5		Α		
VOUT Sink Current Limit		ILIM_VOUT_SK	VOUT in PGOOD window	3	4.5		Α		
VOUT Discharge Resistance		RDISCHARGE	$V_{REFIN} = 0V$, $V_{OUT} = 0.3V$, $V_{EN} = 0V$		18	25	Ω		
Power Good Com	parator								
			V _{SENSE} lower threshold with respect to REFOUT		-20				
PGOOD Threshold		VTH_PGOOD	V _{SENSE} upper threshold with respect to REFOUT	1	20		%		
			PGOOD hysteresis	ł	5				
PGOOD Start-Up [Delay	Tpgdelay1	Start-up rising delay, VSENSE within PGOOD range		2		ms		
Output Low Voltage	е	VLOW_PGOOD	IPGOOD = 4mA			0.4	V		
PGOOD Falling De	elay	T _{PGDELAY2}	Falling delay, V _{SENSE} is out of PGOOD range		10		μS		
Leakage Current		ILEAKAGE _PGOOD	Vsense = V _{REFIN} (PGOOD high impedance), V _{PGOOD} = V _{CNTL} + 0.2V			1	μА		
REFIN and REFO	JT				•	•	•		
REFIN Input Curre	nt	IREFIN	VEN = VCNTL			1	μΑ		
REFIN Voltage Rai	nge	VREFIN		0.5		1.8	V		
REFIN Under-Volta	ige	Ving o DEEM	REFIN rising	360	390	420	mV		
Lockout		Vuvlo_refin	Hysteresis		20		1117		
		VTOL_REFOUT	-10mA < I _{REFOUT} < 10mA, V _{REFIN} = 0.75V	_15 15					
REFOUT Voltage 1 to VREFIN	olerance		-10mA < I _{REFOUT} < 10 mA, V _{REFIN} = 0.675 V	-15		15	mV		
			-10mA < I _{REFOUT} < 10mA, V _{REFIN} = 0.6V	-15		15			
REFOUT Source C Limit	Current	ILIM_REFOUT_SR	V _{REFOUT} = 0V	10	40		mA		
REFOUT Sink Curi	rent Limit	ILIM_REFOUT_SK	VREFOUT = REFIN + 1V	10	40		mA		
UVLO/EN									
UVLO Threshold		Vuvlo_vcntl	Rising	2.5	2.7	2.85	V		
		VOVEO_VCIVIE	Hysteresis		120		mV		
Livinput	gic-High	V _{IN_H}		1.7			_V		
Voltage Lo	gic-Low	V _{IN_L}				0.3	, v		
EN Turn On Delay		t _{DELAY}	EN is turned on to VOUT rising T _A = 25°C (reference Note 5)	1		7	μS		
Thermal Shutdow	n								
Thermal Shutdown		T _{SD}	Shutdown temperature (Note 5)		160		°C		
Threshold		· 3D	Hysteresis (Note 6)		15		$oxedsymbol{oxed}$		



- Note 1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at T_A = 25°C on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. t_{DELAY} is the maximum period form EN turn on to V_{OUT} rising period as follows diagram. While T_{SS} is the rising period of V_{OUT}, the formula used to calculated this rising period is T_{SS} = (V_{OUT} x C_{OUT})/I_{LIM}, it's base on the value of output capacitor C_{OUT} , the settled output voltage V_{OUT} and the output current limit I_{LIM} .
- Note 6. Guarantee by design.





Typical Application Circuit

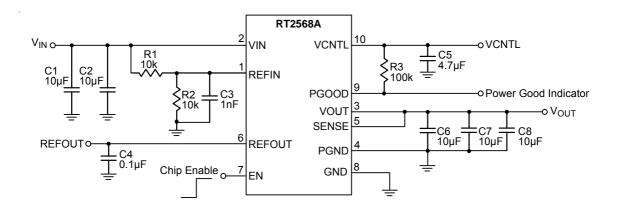


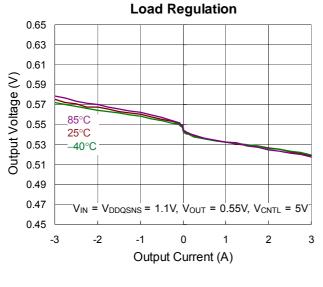
Table 1. Recommended External Components

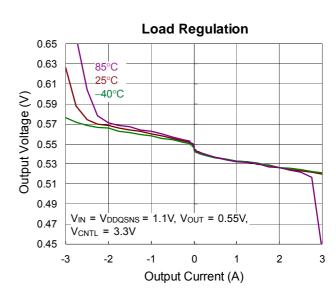
Component	Description	Vendor P/N			
C1, C2, C6, C7, C8	10μF, 6.3V, X7R, 0805	GRM21BR70J106KE76L (Murata) CGA4J1X7R0J106K125AC (TDK)			
C3	1nF, 50V, X7R, 0603	GCD188R71H102KA01D (Murata) CGA3E2X7R1H102K080AA (TDK)			
C4	0.1μF, 16V, X7R, 0603	GCJ188R71C104KA01D (Murata)			
C5	4.7μF, 6.3V, X5R, 0603	GRT188R60J475ME01D (Murata) CGB3B3X5R0J475M055AB(TDK)			

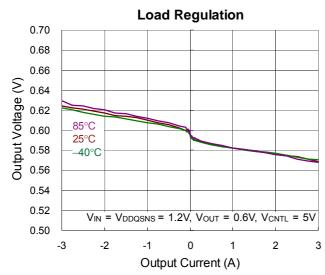
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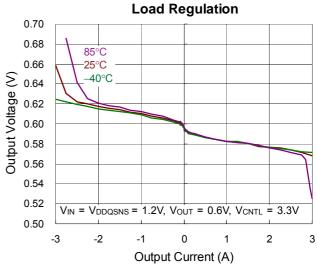


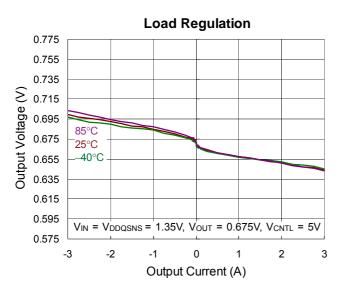
Typical Operating Characteristics

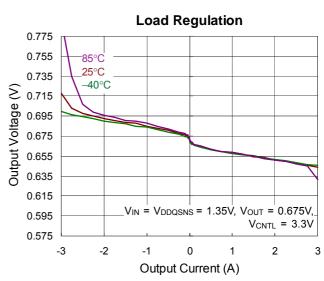






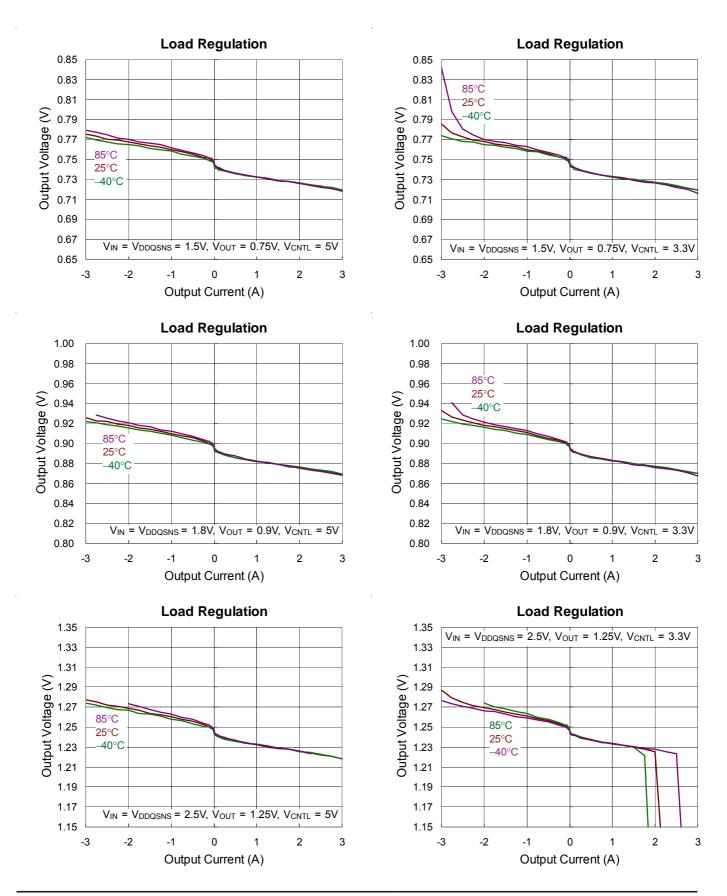




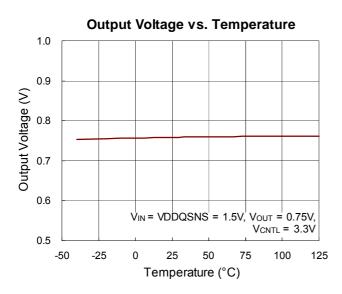


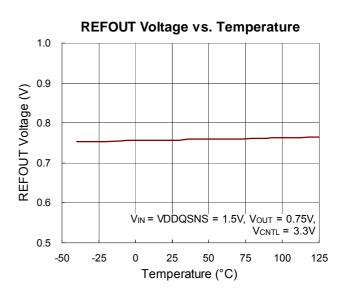
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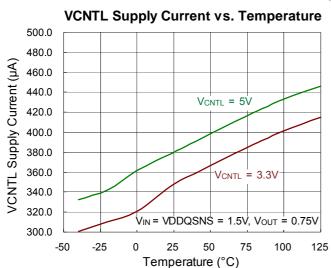


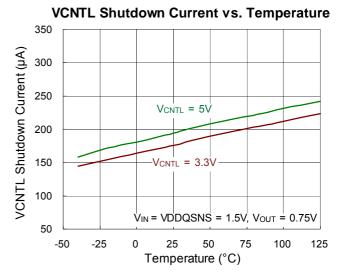


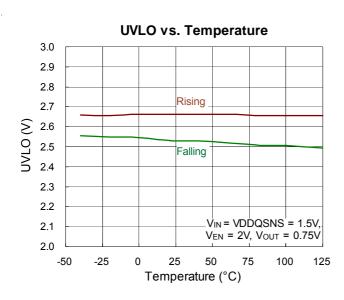


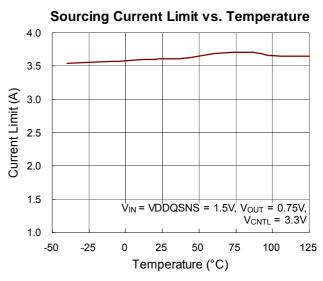


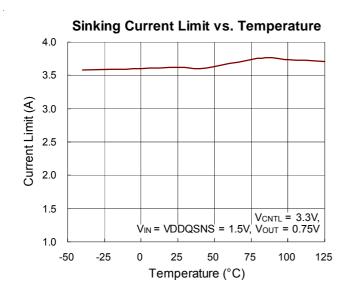


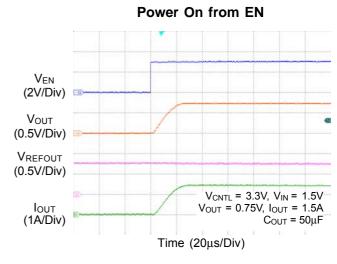


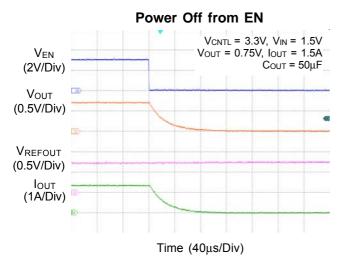


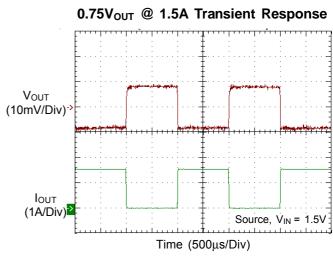


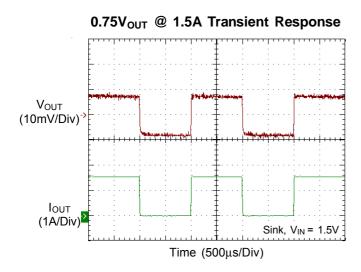














Application Information

The RT2568A is a 3A sink/source tracking termination regulator. It is specifically designed for low-cost and low-external component count system such as notebook PC applications. The RT2568A possesses a high speed operating amplifier that provides fast load transient response and only requires two $10\mu F$ ceramic input capacitors and three $10\mu F$ ceramic output capacitors.

Capacitor Selection

Good bypassing is recommended from VIN to GND to help improve AC performance. A $10\mu F$ or greater input capacitor located as close as possible to the IC is recommended. The input capacitor must be located at a distance of less than 0.5 inches from the VIN pin of the IC.

The $1\mu F$ ceramic capacitor added close to the VCNTL pin should be kept away from any parasitic impedance from the supply power. For stable operation, the total capacitance of the ceramic capacitor at the VTT output terminal must be larger than $30\mu F$. The RT2568A is designed specifically to work with low ESR ceramic output capacitor in space saving and performance consideration. Larger output capacitance can reduce the noise and improve load transient response, stability and PSRR. The output capacitor should be located near the VTT output terminal pin as close as possible.

Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature $T_{J(MAX)}$, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula :

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating

Conditions is 125°C. The junction-to-ambient thermal resistance, θ_{JA} , is highly package dependent. For a WDFN-10L 3x3 package, the thermal resistance, θ_{JA} , is 30.5°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at T_A = 25°C can be calculated as below:

 $P_{D(MAX)}$ = (125°C - 25°C) / (30.5°C/W) = 3.27W for a WDFN-10L 3x3 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed $T_{J(MAX)}$ and the thermal resistance, θ_{JA} . The derating curves in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

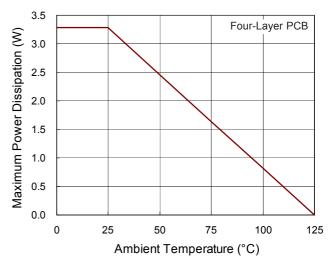


Figure 1. Derating Curve of Maximum Power Dissipation

Layout Considerations

For best performance of the RT2568A, the PCB layout suggestions below are highly recommend:

- ▶ With wide and short connection plane between capacitors and pins for trace impedance minimization.
- The ground plane connected by a wide copper surface for good thermal dissipation, add via connection also helps reduce the GND loop trace.
- Connect the SENSE pin to the positive node of output capacitor at V_{OUT} terminal for output target level remote sensing.

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Since the output voltage V_{OUT} setting follows the REFIN pin input voltage level V_{REFIN} (V_{OUT} = V_{REFIN}), the REFIN pin can connected with independent voltage source for stable input signal and good V_{OUT} target accuracy. For the application which V_{REFIN} sinks the voltage source divided from VIN power trace, with separate connection trace between R1 and VIN terminal side not only makes sure the V_{REFIN} signal stability, but also avoids the reference voltage level shrink down caused by V_{IN} trace loss at high load operation.

Figure 2 shows an example for the layout reference that reduces conduction trace loop, helping minimize inductive parasitic minimize reduce, load transient, and increase circuit stability.

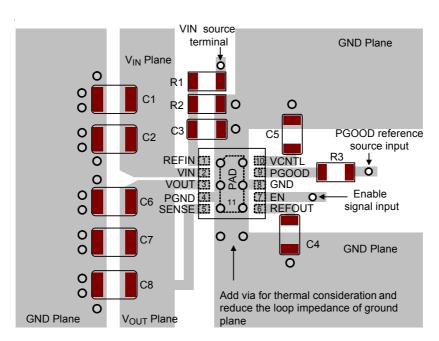
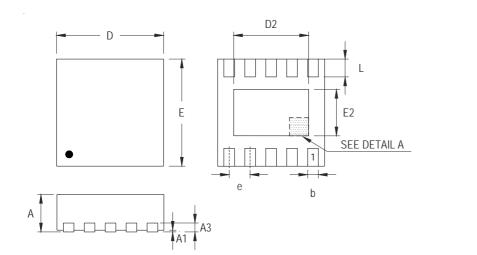


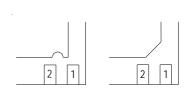
Figure 2. PCB Layout Guide

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Outline Dimension





DETAIL A

Pin #1 ID and Tie Bar Mark Options

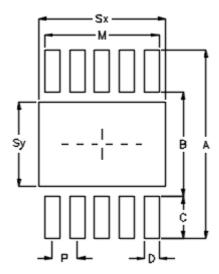
Note: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min	Max	Min	Max		
Α	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A3	0.175	0.250	0.007	0.010		
b	0.180	0.300	0.007	0.012		
D	2.950	3.050	0.116	0.120		
D2	2.300	2.650	0.091	0.104		
Е	2.950	3.050	0.116	0.120		
E2	1.500	1.750	0.059	0.069		
е	0.5	500	0.0)20		
L	0.350	0.450	0.014	0.018		

W-Type 10L DFN 3x3 Package



Footprint Information



Package	Number of	Footprint Dimension (mm)						Tolerance		
	Pin	Р	Α	В	С	D	Sx	Sy	М	Tolerance
V/W/U/X/ZDFN3*3-10	10	0.50	3.80	2.10	0.85	0.30	2.55	1.70	2.30	±0.05

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